

# JMV4708ND

## *Product Preview*

**30V 50A N-Channel MOSFET**

**Features**

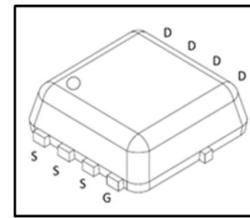
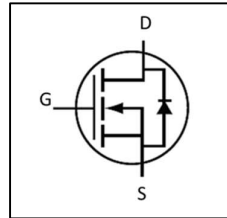
- Advanced shielded-gate technology
- Ultra-low on-resistance and gate-charge
- RoHS compliant
- 100% avalanche tested



Product Summary	
V <sub>DS</sub>	30V
R <sub>DS(ON)</sub>	1.9 mΩ (Typ.)
	2.4 mΩ (Max.)
I <sub>D</sub>	50A

**Applications**

- Motor controllers
- DC-to-DC convertors
- Battery-driven electronic products, electrical equipment and machines


**Ordering Information**

Part Number	Marking	Package	Packaging
JMV4708ND	4708ND	DFN3.3x3.3	Tape & Reel

**Absolute Maximum Ratings**

Parameter	Symbol	Limit	Unit
Drain-to-Source Voltage	$V_{DS}$	30	V
Gate-to-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current, Package Limited ( $T_C = 25^\circ\text{C}$ ) <sup>(1)</sup>	$I_D$	50	A
Continuous Drain Current, Silicon Limited ( $T_C = 25^\circ\text{C}$ ) <sup>(1)</sup>	$I_D$	119	
Continuous Drain Current, Silicon Limited ( $T_C = 100^\circ\text{C}$ ) <sup>(1)</sup>	$I_D$	75	
Continuous Drain Current, Silicon Limited t ( $T_A = 25^\circ\text{C}$ ) <sup>(2), (5)</sup>	$I_D$	24	
Continuous Drain Current, Silicon Limited ( $T_A = 100^\circ\text{C}$ ) <sup>(2), (5)</sup>	$I_D$	15	
Pulsed Drain Current <sup>(3)</sup>	$I_{DM}$	200	
Power Dissipation ( $T_C = 25^\circ\text{C}$ )	$P_D$	56.8	W
Linear Derating Factor	-	0.45	W/ $^\circ\text{C}$
Single Pulse Avalanche Energy <sup>(4)</sup>	$E_{AS}$	83.5	mJ
Avalanche Current <sup>(4)</sup>	$I_{AS}$	26	A
Junction Temperature	$T_J$	-55 to 150	$^\circ\text{C}$
Storage Temperature	$T_{STG}$	-55 to 150	

**Thermal Characteristics**

Parameter	Symbol	Max	Unit
Junction-to-Ambient Thermal Resistance <sup>(5)</sup>	$R_{\theta JA}$	55	$^\circ\text{C}/\text{W}$
Junction-to-Case Thermal Resistance	$R_{\theta JC}$	2.2	

**Static Electrical Characteristics <sup>(6)</sup>**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-to-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	30	-	-	V
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1.1	-	2.2	
Drain-to-Source Leakage Current	$I_{DSS}$	$V_{DS} = 30\text{V}, V_{GS} = 0\text{V}$	-	-	1	$\mu\text{A}$
Gate-to-Source Leakage Current	$I_{GSS}$	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$	-	-	$\pm 100$	nA
Drain-to-Source On-Resistance	$R_{DS(ON)}$	$V_{GS} = 10\text{V}, I_D = 10\text{A}$	-	1.9	2.4	m $\Omega$
		$V_{GS} = 4.5\text{V}, I_D = 10\text{A}$	-	2.9	3.7	m $\Omega$

**Dynamic Electrical Characteristics <sup>(6)</sup>**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Forward Transconductance	$g_{fs}$	$V_{DS} = 5V, I_D = 20A$	-	90	-	S
Total Gate Charge	$Q_g$	$V_{GS} = 10V,$ $V_{DS} = 15V,$ $I_D = 20A$	-	29.5	-	nC
Gate-to-Source Charge	$Q_{gs}$		-	6.0	-	
Gate-to-Drain Charge	$Q_{gd}$		-	5.5	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = 10V,$ $V_{DS} = 15V,$ $I_D = 20A,$ $R_G = 3.0\Omega$	-	15	-	ns
Rise Time	$t_r$		-	5	-	
Turn-Off Delay Time	$t_{d(off)}$		-	35	-	
Fall Time	$t_f$		-	9	-	
Input Capacitance	$C_{iss}$	$V_{GS} = 0V,$ $f = 1MHz,$ $V_{DS} = 15V$	-	2225	-	pF
Output Capacitance	$C_{oss}$		-	986	-	
Reverse Transfer Capacitance	$C_{rss}$		-	100	-	

**Diode Characteristics <sup>(6)</sup>**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Forward Voltage	$V_{SD}$	$V_{GS} = 0V, I_S = 10A$	-	0.8	-	V
Reverse Recovery Time	$t_{rr}$	$V_{GS} = 0V, I_S = 10A,$ $di_S/dt = 100A/\mu s$	-	24	-	ns
Reverse Recovery Charge	$Q_{rr}$		-	30	-	nC

(1) Rated according to  $R_{\theta JC}$ .

(2) Rated according to  $R_{\theta JA}$ .

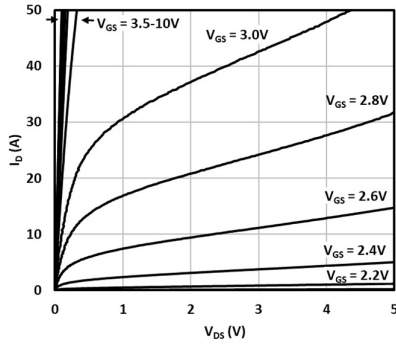
(3) Limited by maximum  $T_J$ .

(4)  $T_A = 25^\circ C, L = 0.1mH, I_{AS} = 26A$ .

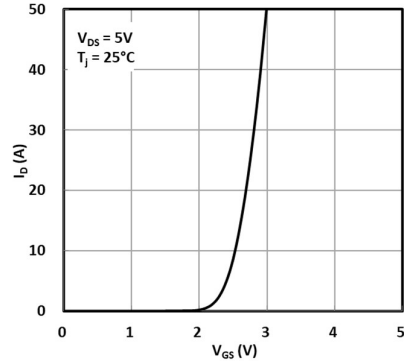
(5) Surface-mounted on 1 inch<sup>2</sup> FR4 board, 2 oz Cu.

(6)  $T_J = 25^\circ C$  unless otherwise specified.

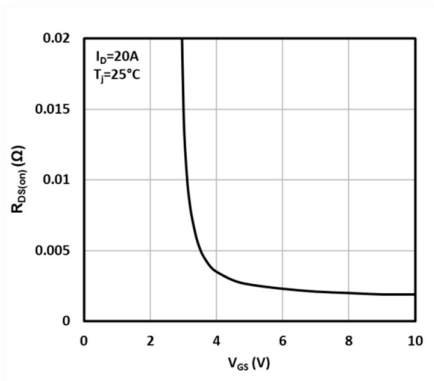
**Typical Electrical Characteristics**



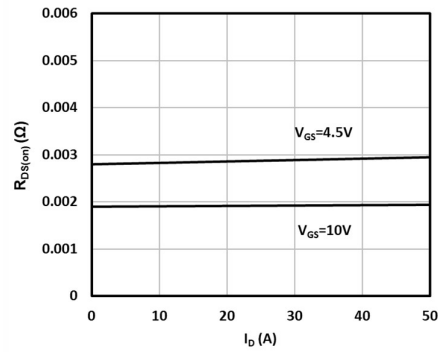
**Fig. 1 Output characteristics**



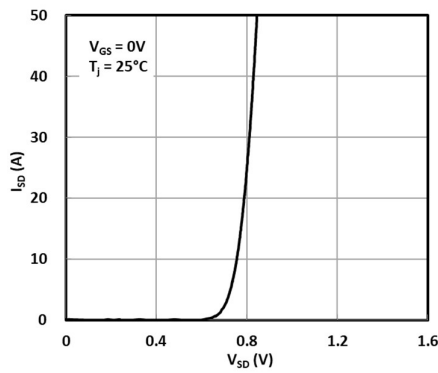
**Fig. 2 Transfer characteristics**



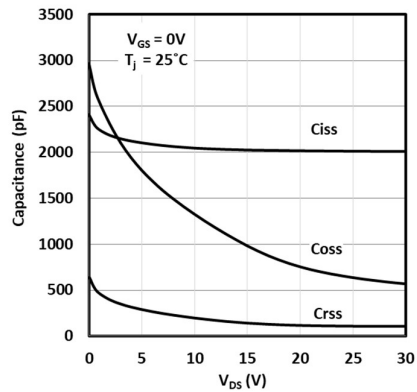
**Fig.3 On-resistance vs. gate voltage**



**Fig.4 On-resistance vs. drain current**



**Fig.5 Source-to-drain diode forward characteristics**



**Fig.6 Capacitance vs. drain-to-source voltage**

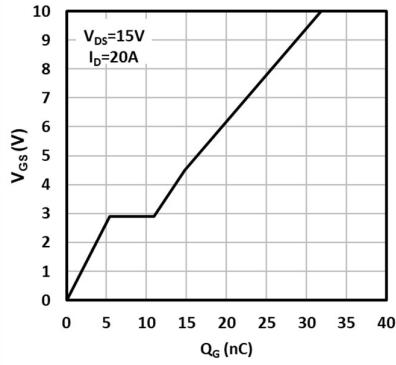


Fig.7 Gate-to-source voltage vs. gate charge

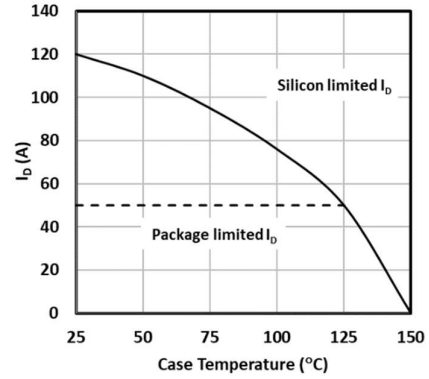


Fig.8 Maximum drain current vs. case temperature

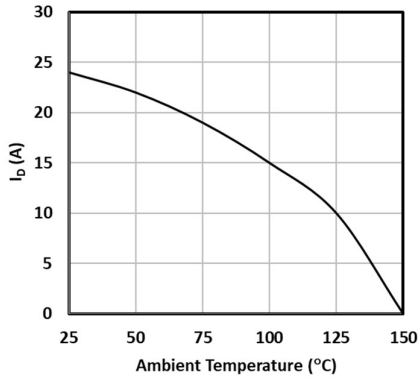
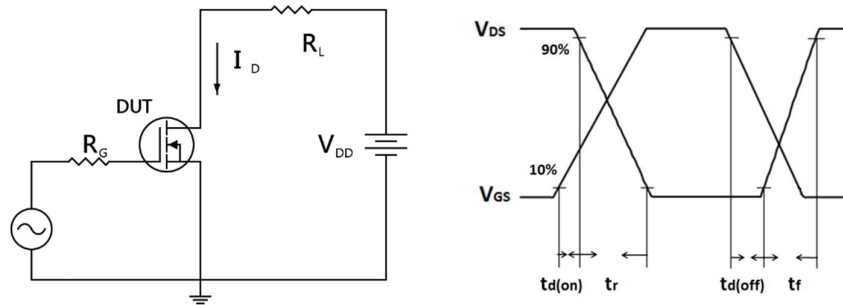
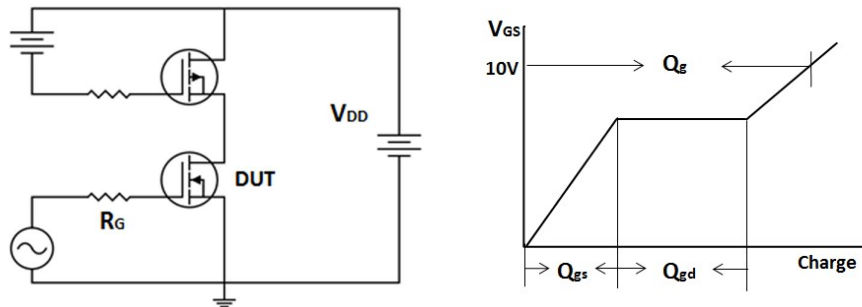


Fig. 9 Maximum drain current vs. ambient temperature

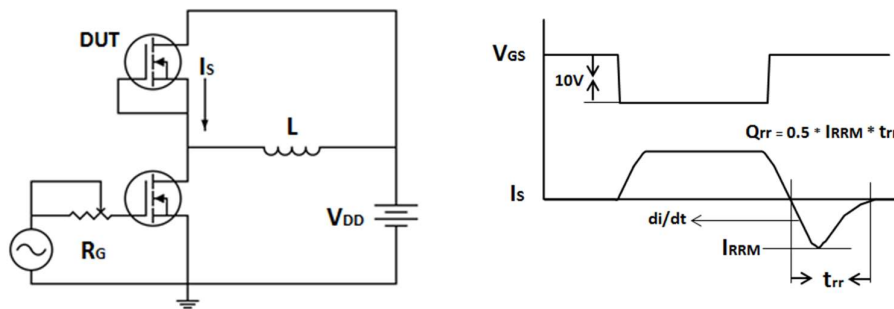
**Test Circuits and Waveforms**



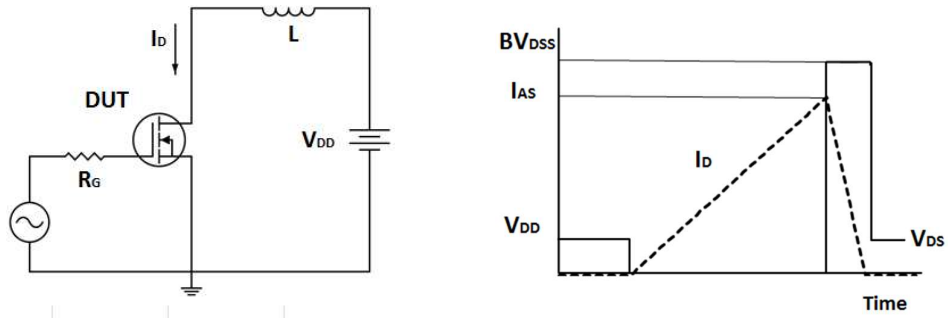
**Resistive switching time test circuit & waveforms**



**Gate charge test circuit & waveform**

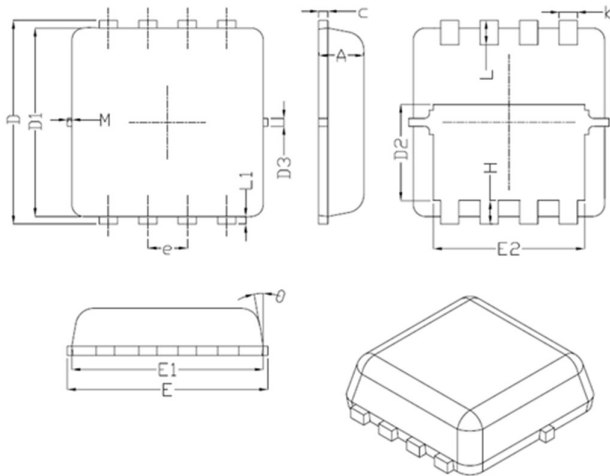


**Peak diode recovery dv/dt test circuit & waveforms**



**Unclamped inductive switching test circuit & waveforms**

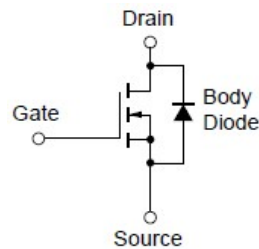
**Package Drawing**



DIM.	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.70	0.80	0.90
b	0.25	0.32	0.39
c	0.10	0.15	0.25
D	3.00	3.30	3.60
D1	3.00	3.10	3.50
D2	1.48	2.00	2.20
D3	--	0.20	--
E	3.00	3.30	3.60
E1	3.00	3.10	3.25
E2	2.29	2.49	2.69
e	0.65 BSC		
H	0.15	0.25	0.50
L	0.15	0.40	0.60
L1	0.05	0.15	0.25
$\alpha$	8°	10°	12°
M	--	0.10	--

**DFN 3.3x3.3**

**Equivalent Circuit**





**Revision history of JMV4708ND specification**

<b>Version</b>	<b>Change Items</b>	<b>Effective Date</b>
1.00	Initial Release	20-Aug-20

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